

# MOS FIELD EFFECT TRANSISTOR 2SK2414, 2414-Z

# SWITCHING N-CHANNEL POWER MOS FET

#### **DESCRIPTION**

The 2SK2414 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

#### **FEATURES**

<R>

· Low On-Resistance

 $R_{DS(on)1} = 70$  m $\Omega$  MAX. (VGS = 10 V, ID = 5.0 A)  $R_{DS(on)2} = 95$  m $\Omega$  MAX. (VGS = 4 V, ID = 5.0 A)

- Low Ciss: Ciss = 860 pF TYP.
- · Built-in G-S Gate Protection Diodes
- · High Avalanche Capability Ratings

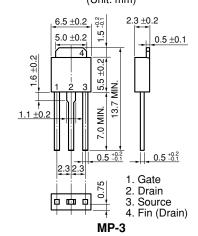
#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C)

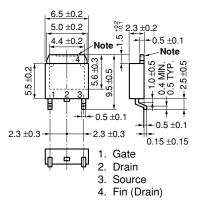
| Drain to Source Voltage                          | VDSS                  | 60          | V                  |
|--|-----------------------|-------------|--------------------|
| Gate to Source Voltage                           | Vgss                  | ±20         | V                  |
| Drain Current (DC)                               | $I_{D(DC)}$           | ±10         | Α                  |
| Drain Current (pulse) Note 1                     | I <sub>D(pulse)</sub> | ±40         | Α                  |
| Total Power Dissipation (Tc = 25 °C)             | P <sub>T1</sub>       | 20          | W                  |
| Total Power Dissipation (T <sub>A</sub> = 25 °C) | P <sub>T2</sub>       | 1.0         | W                  |
| Channel Temperature                              | Tch                   | 150         | $^{\circ}\text{C}$ |
| Storage Temperature                              | T <sub>stg</sub>      | -55 to +150 | $^{\circ}\text{C}$ |
| Single Avalanche Current Note 2                  | las                   | 10          | Α                  |
| Single Avalanche Energy Note 2                   | Eas                   | 10          | mJ                 |
|  |                       |             |                    |

**Notes 1** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

2 Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V

# <R> PACKAGE DIMENSIONS (Unit: mm)

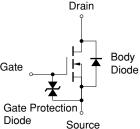




Note The depth of notch at the top of the fin is from 0 to 0.2 mm.

#### MP-3Z (SURFACE MOUNT TYPE)

#### **EQUIVALENT CIRCUIT**



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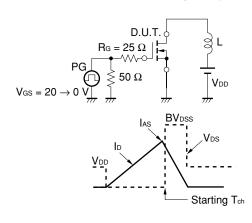


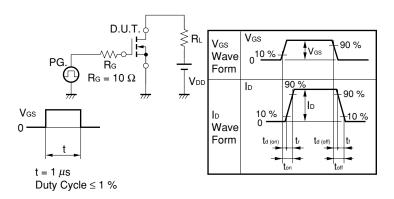
# **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

| CHARACTERISTIC                 | SYMBOL               | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS                                |
|--------------------------------|----------------------|------|------|------|------|--|
| Drain to Source On-Resistance  | RDS(on)1             |      | 52   | 70   | mΩ   | Vgs = 10 V, ID = 5.0 A                         |
| Drain to Source On-Resistance  | RDS(on)2             |      | 68   | 95   | mΩ   | Vgs = 4 V, ID = 5.0 A                          |
| Gate to Source Cutoff Voltage  | V <sub>GS(off)</sub> | 1.0  | 1.6  | 2.0  | V    | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA  |
| Forward Transfer Admittance    | <b>y</b> fs          | 7.0  | 12   |      | S    | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.0 A |
| Drain Leakage Current          | IDSS                 |      |      | 10   | μΑ   | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V  |
| Gate to Source Leakage Current | Igss                 |      |      | ±10  | μΑ   | Vgs = ±20 V, Vps = 0 V                         |
| Input Capacitance              | Ciss                 |      | 860  |      | pF   | V <sub>DS</sub> = 10 V                         |
| Output Capacitance             | Coss                 |      | 440  |      | pF   | Vgs = 0 V                                      |
| Reverse Transfer Capacitance   | Crss                 |      | 110  |      | pF   | f = 1 MHz                                      |
| Turn-On Delay Time             | td(on)               |      | 15   |      | ns   | ID = 5.0 A                                     |
| Rise Time                      | tr                   |      | 90   |      | ns   | V <sub>GS</sub> = 10 V                         |
| Turn-Off Delay Time            | t <sub>d(off)</sub>  |      | 75   |      | ns   | V <sub>DD</sub> = 30 V                         |
| Fall Time                      | tf                   |      | 35   |      | ns   | R <sub>G</sub> = 10 Ω                          |
| Total Gate Charge              | QG                   |      | 24   |      | nC   | ID = 10 A                                      |
| Gate to Source Charge          | Qgs                  |      | 2.6  |      | nC   | V <sub>DD</sub> = 48 V                         |
| Gate to Drain Charge           | Q <sub>GD</sub>      |      | 6.0  |      | nC   | V <sub>GS</sub> = 10 V                         |
| Body Diode Forward Voltage     | V <sub>F(S-D)</sub>  |      | 1.0  |      | V    | IF = 10 A, VGS = 0 V                           |
| Reverse Recovery Time          | trr                  |      | 85   |      | ns   | IF = 10 A, VGS = 0 V                           |
| Reverse Recovery Charge        | Qrr                  |      | 220  |      | nC   | di/dt = 50 A/μs                                |

# Test Circuit 1 Avalanche Capability

# Test Circuit 2 Switching Time





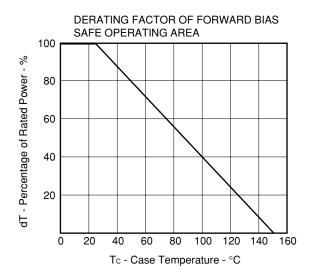
### Test Circuit 3 Gate Charge

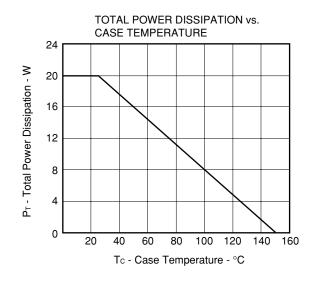
$$PG = 2 \frac{\text{mA}}{\text{Vol}}$$

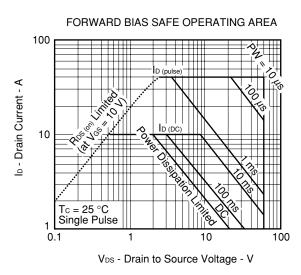
$$PG = 3 \frac{\text{mA}}{\text{Vol}}$$

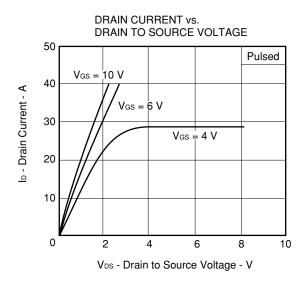
$$V_{DD}$$

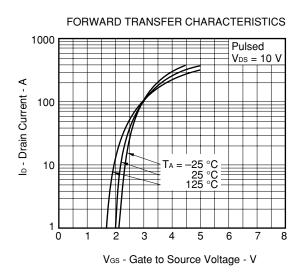
### TYPICAL CHARACTERISTICS (TA = 25 °C)



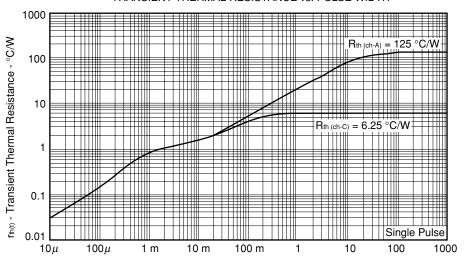




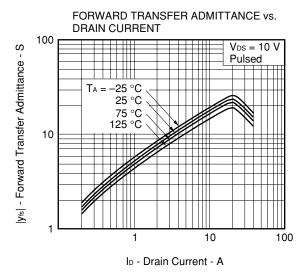


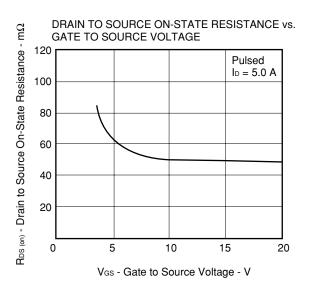


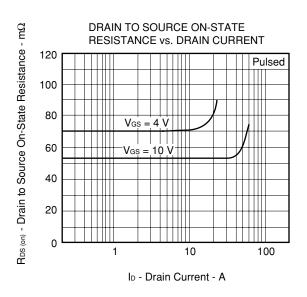
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

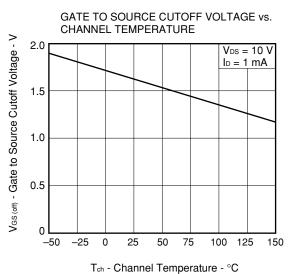


PW - Pulse Width - s

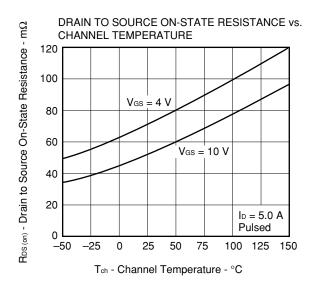


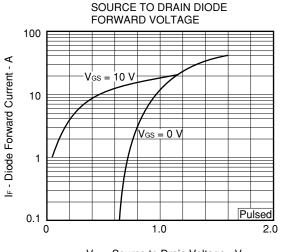


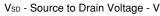


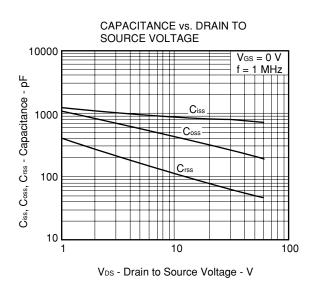


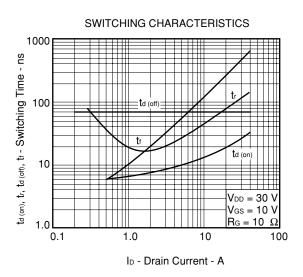
Ten - Onanner Temperature - V

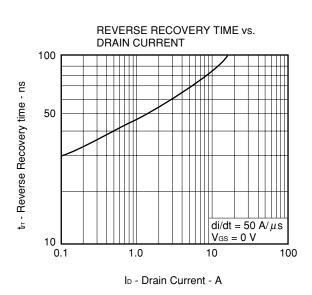


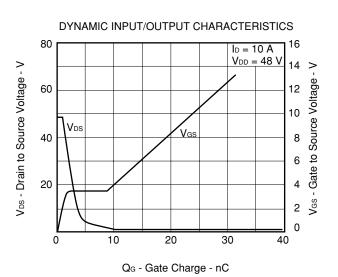


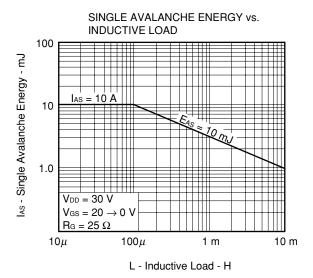


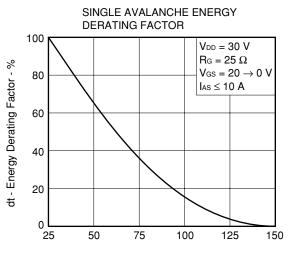












Starting  $T_{\text{ch}}$  - Starting Channel Temperature -  $^{\circ}C$ 

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